

# LOW DROP DUAL POWER OPERATIONAL AMPLIFIER

- OUTPUT CURRENT TO 1 A
- OPERATES AT LOW VOLTAGES
- SINGLE OR SPLIT SUPPLY
- LARGE COMMON-MODE AND DIFFERENTIAL MODE RANGE
- LOW INPUT OFFSET VOLTAGE
- GROUND COMPATIBLE INPUTS
- LOW SATURATION VOLTAGE
- THERMAL SHUTDOWN
- CLAMP DIODE



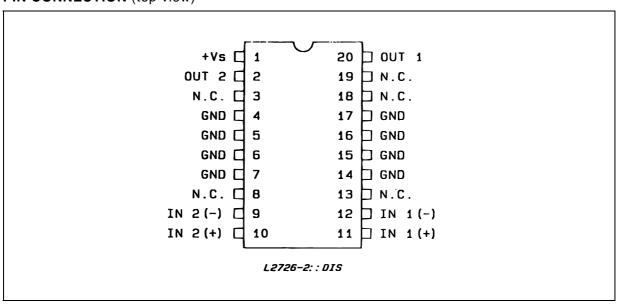
#### **DESCRIPTION**

The L2726 is a monolithic integrated circuit in SO-20 package intended for use as power operational amplifiers in a wide range of applications including servo amplifiers and power supplies.

It is particularly indicated for driving inductive loads, as motor and finds applications in compact-disc VCR automative, etc.

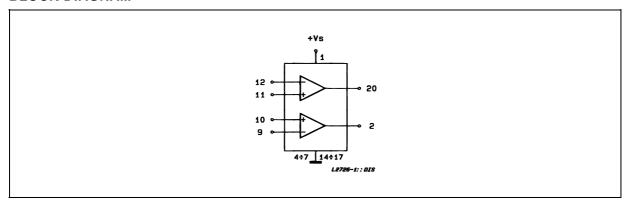
The high gain and high output power capability provide superior performance whatever an operational amplifier/power booster combination is required.

#### PIN CONNECTION (top view)

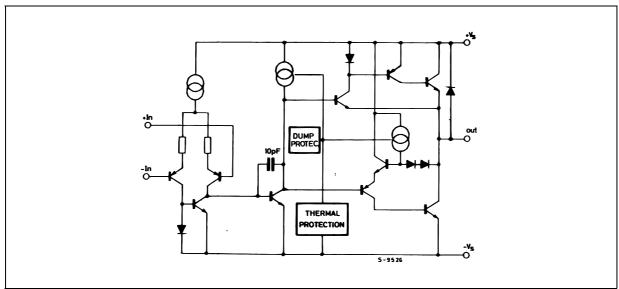


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### **BLOCK DIAGRAM**



# SCHEMATIC DIAGRAM (one section)



## **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
Vs	Supply Voltage	28	V
Vs	Peak Supply Voltage (50ms)	50	V
Vi	Input Voltage	Vs	
Vi	Differential Input Voltage	± V <sub>s</sub>	
Ιο	DC Output Current	1	Α
Ιp	Peak Output Current (non repetitive)	1.5	Α
P <sub>tot</sub>	Power Dissipation at $T_{amb} = 85^{\circ}C$ $T_{case} = 75^{\circ}C$	1 5	W
T <sub>op</sub>	Operating Temperature	- 40 to 85	°C
T <sub>stg</sub> , T <sub>j</sub>	Storage and Junction Temperature	- 40 to 150	°C

## THERMAL DATA

R <sub>th j-case</sub>	Thermal Resistance Junction-case	Max.	15.0	°C/W
R <sub>th j-amb</sub>	Thermal Resistance Junction-ambient (*)	Max.	65	°C/W

<sup>(\*)</sup> With 4 sq. cm copper area heatsink.

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## **ELECTRICAL CHARACTERISTICS**

 $V_s = 24V$ ,  $T_{amb} = 25^{\circ}C$  unless otherwise specified

Symbol	Parameter	Test Condi	tions	Min.	Тур.	Max.	Unit
Vs	Single Supply Voltage			4		28	V
Vs	Split Supply Voltage			± 2		± 14	V
Is	Quiescent Drain Current	$V_0 = \frac{V_s}{2}$	V <sub>s</sub> = 24V		10	15	mA
			$V_s = 24V$		9	15	
I <sub>b</sub>	Input Bias Current				0.2	1	μΑ
Vos	Input Offset Voltage					10	mV
Ios	Input Offset Current					100	nA
SR	Slew Rate				2		V/μs
В	Gain-bandwidth Product				1.2		MHz
Ri	Input Resistance			500			kΩ
G <sub>v</sub>	O. L. Voltage Gain	f = 100Hz f = 1kHz		70	80 60		dB
e <sub>N</sub>	Input Noise Voltage	B = 22Hz to 22kHz			10		μV
I <sub>N</sub>	Input Noise Voltage	B = 22H2 (0 22KH2			200		рА
CMR	Common Mode Rejection	f = 1kHz		66	84		dB
SVR	Supply Voltage Rejection	$\begin{array}{l} f = 100 Hz \\ R_G = 10 k\Omega \\ V_R = 0.5 V \end{array}$	$V_s = 24V$ $V_s = \pm 12V$ $V_s = \pm 6V$	60	70 75 80		dB dB dB
V <sub>DROP(HIGH)</sub>		$V_s = \pm 2.5 V \text{ to } \pm 12 V$	$I_p = 100 \text{mA}$ $I_p = 500 \text{mA}$		0.7 1	1.5	V
V <sub>DROP(LOW)</sub>		$V_s = \pm 2.5 V \text{ to } \pm 12 V$	$I_p = 100 \text{mA}$ $I_p = 500 \text{mA}$		0.3 0.5	1	V
Cs	Channel Separation	$ f = 1 KHz \\ R_L = 10 \Omega \\ G_V = 30 dB $	V <sub>s</sub> = 24V V <sub>s</sub> = 6V		60 60		dB
T <sub>sd</sub>	Thermal Shutdown Junction Temperature			150			°C

Figure 1 : Quiescent Current vs. Supply Voltage

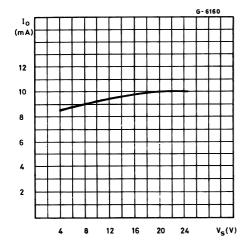


Figure 2: Open Loop Gain vs. Frequency

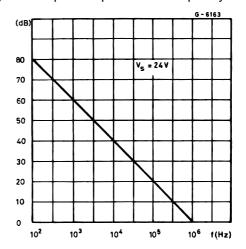


Figure 3 : Common Mode Rejection Frequency

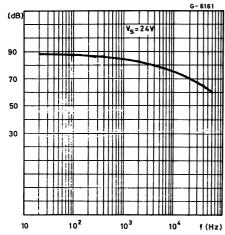


Figure 5 : Output Swing vs. Load Current  $(V_s = \pm 12 \text{ V})$ 

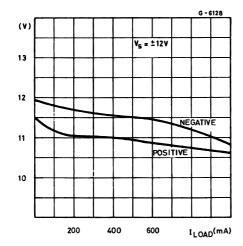


Figure 7: Channel Separation vs. Frequency.

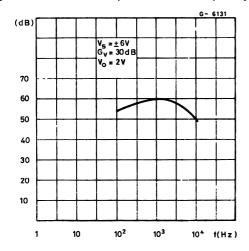
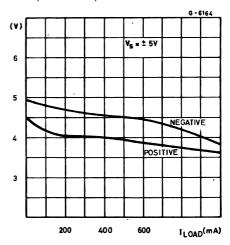
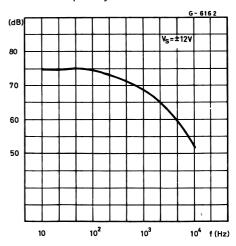


Figure 4 : Output Swing vs. Load Current  $(V_s = \pm 5V)$ 



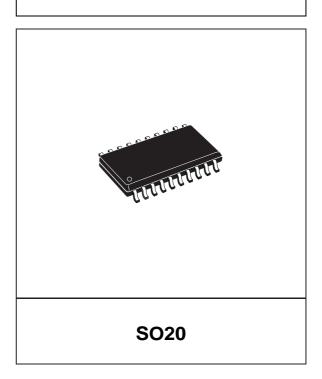
**Figure 6 :** Supply Voltage Rejection vs. Frequency

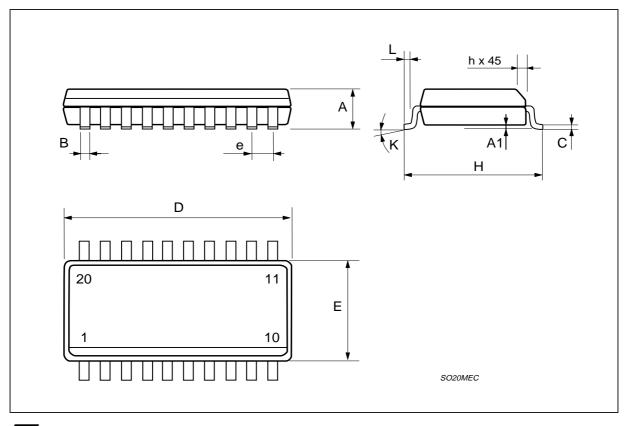


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DIM.	mm			inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Α	2.35		2.65	0.093		0.104	
A1	0.1		0.3	0.004		0.012	
В	0.33		0.51	0.013		0.020	
С	0.23		0.32	0.009		0.013	
D	12.6		13	0.496		0.512	
Е	7.4		7.6	0.291		0.299	
е		1.27			0.050		
Н	10		10.65	0.394		0.419	
h	0.25		0.75	0.010		0.030	
L	0.4		1.27	0.016		0.050	
К	0° (min.)8° (max.)						

# OUTLINE AND MECHANICAL DATA





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